## **MOSFET** – Single P-Channel, Small Signal, SOT-23

## -8.0 V, -3.7 A

#### Features

- Leading Trench Technology for Low RDS(on)
- -1.8 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint (3 x 3 mm)
- This is a Pb–Free Device

#### Applications

- High Side Load Switch
- DC–DC Conversion
- Cell Phone, Notebook, PDAs, etc.

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V <sub>DSS</sub>	-8.0	V		
Gate-to-Source Voltage			V <sub>GS</sub>	±8.0	V		
Continuous Drain	t≤5s	$T_A = 25^{\circ}C$	I <sub>D</sub>	-3.7	А		
Current (Note 1)		$T_A = 70^{\circ}C$		-3.0			
Power Dissipation (Note 1)	t ≤ 5 s		t ≤ 5 s		P <sub>D</sub>	0.96	W
Pulsed Drain Current	t <sub>p</sub> = 10 μs		I <sub>DM</sub>	-11	А		
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>STG</sub>	–55 to 150	°C		
Source Current (Body Diode)			I <sub>S</sub>	-1.2	А		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C		

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State	$R_{\theta JA}$	160	°C/W
Junction-to-Ambient – t $\leq$ 5 s	$R_{\theta JA}$	130	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface mounted on FR4 board using 1 in sq pad size

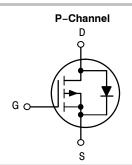
(Cu area = 1.127 in sq [1 oz] including traces).

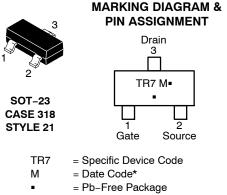


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V <sub>(BR)DSS</sub> R <sub>DS(on)</sub> Typ		I <sub>D</sub> Max
	39 mΩ @ –4.5 V	
–8.0 V	52 mΩ @ –2.5 V	–3.7 A
	79 mΩ @ –1.8 V	





(Note: Microdot may be in either location) \*Date Code orientation may vary depending upon manufacturing location.

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>			
NTR2101PT1G	SOT-23 (Pb-Free)	3000/Tape & Reel			

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

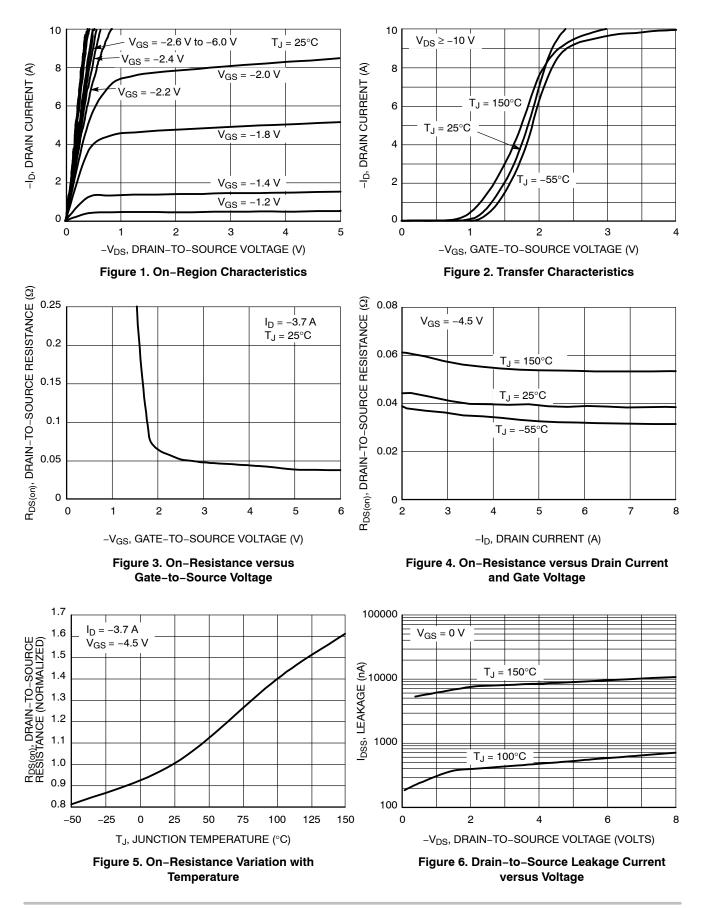
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## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

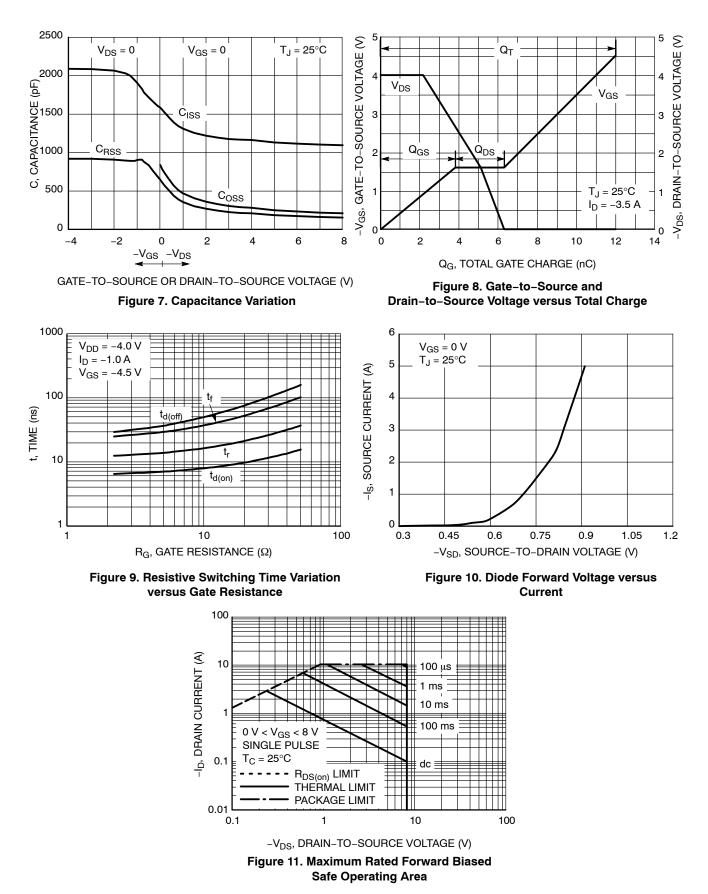
Parameter	Symbol	Test Conc	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							_
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \ \mu\text{A}$		-8.0			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				10		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = -6.4 V	$T_J = 25^{\circ}C$			-1.0	μΑ
			$T_J = 125^{\circ}C$			-100	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ±8.0 V				±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$		-0.40		-1.0	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				2.7		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = -4.5 V, I <sub>D</sub> = -3.5 A			39	52	mΩ
		$V_{GS}$ = -2.5 V, I <sub>D</sub> = -3.0 A			52	72	
		$V_{GS}$ = -1.8 V, I <sub>D</sub> = -2.0 A			79	120	
Forward Transconductance	<b>9</b> FS	$V_{GS}$ = -5.0 V, I <sub>D</sub> = -3.5 A			9.0		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = -4.0 V			1173		pF
Output Capacitance	C <sub>OSS</sub>				289		1
Reverse Transfer Capacitance	C <sub>RSS</sub>				218		1
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS} = -4.5 \text{ V}, V_{DS} = -4.0 \text{ V},$ $I_D = -3.5 \text{ A}$			12	15	nC
Gate-to-Source Charge	Q <sub>GS</sub>				3.8		
Gate-to-Drain Charge	Q <sub>GD</sub>				2.5		
SWITCHING CHARACTERISTICS (Note 3	)						
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{GS}$ = -4.5 V, $V_{DD}$ = -4.0 V, I <sub>D</sub> = -1.2 A, R <sub>G</sub> = 6.0 $\Omega$			7.4	15	ns
Rise Time	t <sub>r</sub>				15.75	25	-
Turn-Off Delay Time	t <sub>d(off)</sub>				38	58	
Fall Time	t <sub>f</sub>				31	51	
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = -1.2 A	$T_J = 25^{\circ}C$		-0.73	-1.2	V

performance may not be indicated by the Electrical Characteristics for the listed test conditions. 2. Pulse Test: pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%. 3. Switching characteristics are independent of operating junction temperatures.

## **TYPICAL CHARACTERISTICS**



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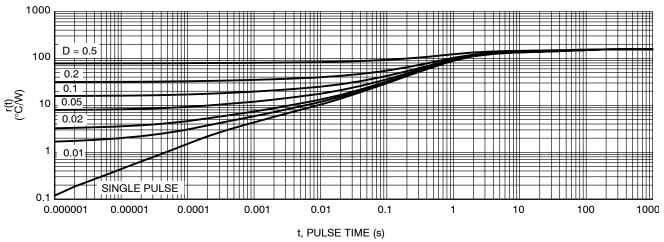
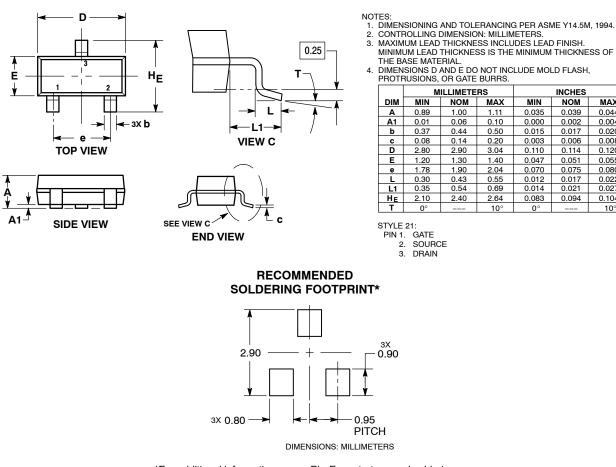


Figure 12. Thermal Response

#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR** 



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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